

PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT						
NATURE OF CONVEYANCE:	ASSIGNMENT						
CONVEYING PARTY DATA							
<table border="1"> <thead> <tr> <th>Name</th> <th>Execution Date</th> </tr> </thead> <tbody> <tr> <td>Sung-Ho CHO</td> <td>09/20/2012</td> </tr> <tr> <td>Woon-Sik LEE</td> <td>09/20/2012</td> </tr> </tbody> </table>		Name	Execution Date	Sung-Ho CHO	09/20/2012	Woon-Sik LEE	09/20/2012
Name	Execution Date						
Sung-Ho CHO	09/20/2012						
Woon-Sik LEE	09/20/2012						
RECEIVING PARTY DATA							
Name:	Samsung Electronics Co., Ltd.						
Street Address:	129, Samsung-ro, Yeongtong-gu, Suwon-si						
City:	Gyeonggi-do						
State/Country:	KOREA, REPUBLIC OF						
PROPERTY NUMBERS Total: 1							
<table border="1"> <thead> <tr> <th>Property Type</th> <th>Number</th> </tr> </thead> <tbody> <tr> <td>Application Number:</td> <td>13650735</td> </tr> </tbody> </table>		Property Type	Number	Application Number:	13650735		
Property Type	Number						
Application Number:	13650735						
CORRESPONDENCE DATA							
Fax Number:	2012269246						
<i>Correspondence will be sent via US Mail when the fax attempt is unsuccessful.</i>							
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NAME OF SUBMITTER:	Steve Cha						
Total Attachments: 2 source=5000-1-1490_Assignment#page1.tif source=5000-1-1490_Assignment#page2.tif							

CH \$40.00 13650735

Assignment of Invention and Patent Application

NOW, THEREFORE, TO ALL WHOM IT MAY CONCERN, be it known that for and in consideration of TEN (\$10.00) DOLLAR,

- 1) Sung- Ho CHO of
#302-402, Mokryeon Woosung APT., Beomgye-dong, Dongan-gu, Anyang-si,
Gyeonggi-do, Republic of Korea

- 2) Woon-Sik LEE of
18/3, #111-201, Hosugongwon APT., 720, Gojan-dong, Danwon-gu, Ansan-si, Gyeonggi-do,
Republic of Korea

(hereinafter Assignor) hereby sells, assigns, transfers, and sets over unto:

**SAMSUNG ELECTRONICS CO., LTD. of
129, Samsung-ro, Yeongtong-gu, Suwon-si, Gyeonggi-do, 443-742,
REPUBLIC OF KOREA**

(hereinafter Assignee) the entire right, title and interest for the United States Of America as defined in 35 U.S.C. §1.00, in and to the invention entitled as:

ELECTRONIC DEVICE CASE AND SURFACE TREATMENT METHOD THEREOF

invented by Assignor; the application for United States patent therefor, invented by Assignor; any patent or reissues of any patent that may be granted thereon; and any applications which are continuations, continuation-in-part, substitutes, or divisions of said application. Assignor authorizes Assignee to enter the date of signature and/or Serial Number and Filing Date in the above. Assignor also authorizes and requests the Commissioner of Patents and Trademarks to issue any resulting patent(s) to the said Assignee, for its interests as Assignee, its successors, assigns and legal representatives. The undersigned agrees that the attorney of record in said application shall hereafter act on behalf of said Assignee; and Assignor further conveys to Assignee all priority rights resulting from the above-identified application for United States Patent. Assignor agrees to execute all papers, give any required testimony and perform other lawful acts, as deemed essential by Assignee to perfect Assignee's interest in any resulting patent of the United States, and to acquire, hold, enforce, convey, and uphold the validity of said patent and reissues and extensions thereof, and Assignee's interest therein.

SIGNED ON THE DATES(S) INDICATED BESIDE MY/OUR SIGNATURE(S):

